

**Amendments to the Claims:**

This listing of claims will replace all prior versions, and listings, of claims in the application:

**Listing of Claims:**

1. (Previously Presented) A door module kit for transportation to the location of assembly of a vehicle door comprising:
  - a non-structural substrate carrier;
  - a door trim panel configured to be coupled to the substrate carrier;
  - a door trim interface member integrally molded with the carrier as a single unitary article;
  - a carrier interface member extending from the door trim panel;wherein the door trim panel is releasably coupled to the carrier during transportation to the location of assembly of the vehicle door by releasable engagement of the door trim interface member and the substrate carrier interface member.
2. (Previously Presented) The door module kit of Claim 1 wherein the door trim interface member is a retainer that defines a space for at least partially receiving the carrier interface member.
3. (Previously Presented) The door module kit of Claim 2 wherein the retainer is a “U”-shaped loop.
4. (Previously Presented) The door module kit of Claim 1 wherein the carrier interface member is a projection that extends from the door trim panel and engages the door trim interface member.
5. (Previously Presented) The door module kit of Claim 4 wherein the carrier interface member is a hook extending from the door trim panel.
6. (Previously Presented) The door module kit of Claim 1 wherein the carrier interface member is integrally molded with the door trim panel.

7. (Previously Presented) The door module kit of Claim 1 wherein the substrate carrier further comprises an integrally molded impact absorber.

8. (Previously Presented) The door module kit of Claim 1 wherein the substrate carrier further comprises an integrally molded pull cup support.

9.–10. (Cancelled)

11. (Original) A method of assembling a vehicle door having a non-structural carrier, a trim panel, and a structural frame, the method comprising:

receiving the carrier and the trim panel at the location for assembly of the vehicle door;

removing the trim panel from the non-structural carrier;

coupling the carrier to the structural frame; and

mounting the trim panel to the non-structural carrier

12. (Previously Presented) The method of Claim 11 further comprising the step of coupling the trim panel to an assembly line fixture when the carrier is coupled to the frame.

13. (Currently Amended) The method of Claim 11 wherein the step of mounting the trim panel to the carrier comprises engaging ~~the~~ a retainer member defined on the trim panel with ~~the~~ a projection defined on the carrier.

14. (Original) The method of Claim 11 wherein the projection extends from the trim panel and the retainer member is integrally molded with the carrier as a unitary article.

15. (Previously Presented) A door module kit for a vehicle door comprising:
- a non-structural substrate carrier having a first interface member and an integrally molded impact absorber;
- a door trim panel configured to be coupled to the substrate carrier and having a second interface member;
- wherein the door trim panel is releasably coupled to the carrier during transportation to the location of assembly of the vehicle door by releasable engagement of the first interface member and the second interface member.
16. (Previously Presented) The door module kit of Claim 15 wherein the first interface member comprises a retainer integrally molded with the carrier and defines a space for at least partially receiving the substrate carrier interface member.
17. (Previously Presented) The door module kit of Claim 16 wherein the second interface member is a projection that extends from the door trim panel and engages space defined by the retainer.
18. (Currently Amended) The door module kit of Claim 15 wherein one of the first interface member and the second interface member are integrally molded with the door trim panel.
19. (Previously Presented) The door module kit of Claim 15 wherein the integrally molded impact absorber comprises an upper integrally molded impact absorber and a lower integrally molded impact absorber.
20. (Previously Presented) The door module kit of Claim 19 wherein the upper impact absorber comprises a series of projections extending from the carrier.
21. (Previously Presented) The door module kit of Claim 19 wherein the lower impact absorber comprises a plurality of walls.
22. (Previously Presented) The door module kit of Claim 15 wherein the substrate carrier further comprises an integrally molded pull cup support.

23. (Currently Amended) A method of assembling a vehicle door having a non-structural carrier, a trim panel, and a structural frame, the method comprising:

receiving the carrier and the trim panel at the location for assembly of the vehicle door;

coupling the trim panel to an assembly line fixture;

coupling the carrier to the structural frame; and

removing the trim panel from ~~frø~~ the assembly line fixture and mounting the trim panel to the non-structural carrier

24. (Previously Presented) The method of Claim 23 wherein the carrier and trim panel are received at the location for assembly of the vehicle door releasably coupled together.

25. (Previously Presented) The method of Claim 24 further comprising the step of removing the trim panel from the non-structural carrier before coupling the trim panel to the assembly line fixture.

26. (Previously Presented) The method of Claim 23 wherein the step of mounting the trim panel to the carrier comprises engaging a retainer member with a projection, wherein the projection extends from the trim panel and the retainer member is integrally molded with the carrier as a unitary article.